查询\$N54L\$320供应商

SN54L5320, SN54L5321, SN74LS320 CRYSTAL-CONTROLLED OSCILLATORS

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'LS320

- Crystal-Controlled Oscillator Operation from 1 MHz to 20 MHz
- 2-Phase Driver Outputs

'LS321

 Similar to 'LS320 But Includes f/2 and f/4 Count-Down Outputs

description

The 'LS320 is a crystal-controlled oscillator/clock driver. It features complementary standard and highcurrent driver outputs. A synchronization flip-flop is included.

The driver outputs, F' and $\overline{F'}$ have very-low impedance and can be used to drive highly capacitive TTL-level lines. If the driver outputs are not used, then the V_{CC}' terminal can be left open.

The 'LS321 is identical to the 'LS320 except it additionally features two count-down outputs, F/2 and F/4.

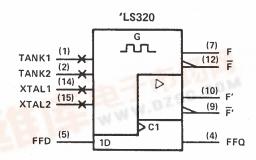
These circuits were designed for crystal control of frequency and capacitive control is not recommended. If a fundamental crystal is used, an inductor of 5 to 160 μ H is required to be connected between the tank 1 and tank 2 inputs. †

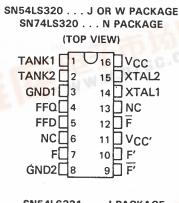
Interaction of the driver outputs with the other outputs limits useful frequencies as shown in the frequencylimits table.

The SN54LS320 and SN54LS321 are characterized for operation over the full military temperature range of -55°C to 125°C. The SN74LS320 and SN74LS321 are characterized for operation from 0°C to 70°C.

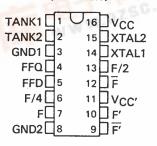
logic symbols[‡]

PDF





SN54LS321 ... J PACKAGE SN74LS321 ... N PACKAGE (TOP VIEW)

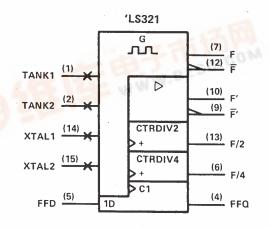


NC - No internal connection

For chip carrier information, contact the factory.

FREQUENCY LIMITS

OUTPUTS IN USE	V _{CC}	V _{CC} ′	f _{max}
Driver outputs only	5 V	5 V	20 MHz
Other outputs only	5 V	Open	20 MHz
Driver and any other outputs	5 V	5 V	10 MHz



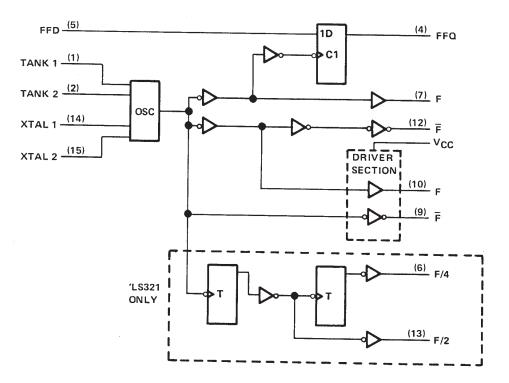
¹The value of the inductor is selected from the graph in Figure 2. Use the next higher standard inductor value if the selected value is not available. If a third overtone crystal is used, a tuned tank is necessary. The center frequency of the tuned tank is determined by the equation f = ½ π/LC.

[‡]These symbols are in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.



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logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V _{CC} (see Note	e 1)																					7.1/
Supply voltage, V _{CC} '										÷		•••	•	•	•	•	•	•	•••	•	•	· · · · · / V
Input voltage to FFD terminal											•	•••	•	·	•	•	•	•	•••	•	·	· · · · / V
Operating free-air temperature	range	: SN	1541	S32(אר	N54	11 57	221	•	·	•	•••	•	•	•	•	•	•	•••	•	•	$-0.5 \times 107^{\circ}$
		SN	741	5320), c) s	N7/	11 53	21		•	•	•••	•	•	•	•	•	•	• •	•	•	-55 C to 125 C . 0°C to 70°C
Storage temperature range ,		0		0020	, 0	- 1.1		21		•	•	•••	•	•	•	•	•	•	• •	·	•	. 0 C to 70 C
,	•••	•••	•	•••	•	•••	• •	•	•	•	•	•••	•	•	•	•	•	•	• •	•	•	-65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminals.

recommended operating conditions

			SN54LS3 SN54LS3]				
				21	UNIT				
		MIN	NOM	MAX	MIN	NOM	MAX		
Supply voltage, VCC	4.5	5	5.5	4.75	5	5.25	V		
Supply voltage, VCC'		4,5	5	5,5	4.75	5	5.25	V	
High-level output current, IOH	F' or F'			-12	1		-24		
	F, F, F/2, F/4			-0.4	1		-0.4	mA	
Low-level output current, IOL	F' or F'			12	<u> </u>		24		
Low-level output current, IOL	F, F, F/2, F/4			4			8	mA	
	F/2 ('LS321)	0.5		10	0.5	· · · · · · · · · · · · · · · · · · ·	10		
Output frequency, fout	F/4 ('LS321)	0.25		5	0.25		5	MHz	
	ForF	1		20	1		20	1	
Operating free-air temperature, T_A	-55		125	0		70	°c		

Input and output schematics are similar to those shown for SN74LS326.



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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER			г	-	N54LS3		S S	UNIT						
							TYP‡	MAX	MIN .	гүр‡	MAX			
VIH	High-level input	voltage				2			2			V		
VIL	Low-level input	voltage						0.7			0.8	V		
VIK	Input clamp vol	tage	V _{CC} = MIN,	V _{CC} ' = MIN,	l₁ = −18 mA			-1.5			-1.5	V		
	High-level	F', F'	V _{CC} = 4.5 V,	V _{CC} ' = 4.5 V,	I _{OH} =12 mA	2.4	3.3							
V _{OH}	output voltage	' , '	V _{CC} = 4.75 V,	V _{CC} ' = 4.75 V,	1 _{OH} = -24 mA				2.7	3.3		v		
		Others	V _{CC} = MIN,	V _{IH} = 2 V,	IOH = -400 μA	2.4	3.4		2.7	3.4		1		
	Low-level output voltage	F', F'	Vcc = MIN,	V _{CC} ' = MIN	IOL = 12 mA		0.25	0.4		0.25	0.4			
VOL		• ,•	VCC	ACC - MILLA	IOL = 24 mA					0.35	0.5	v		
1 OL		output voltage Others V _{CC} = MIN	Vcc = MIN	VIL = VIL max	$I_{OL} = 4 \text{ mA}$		0.25	0.4		0.25	0.4			
			• CC - Mint,		IOL = 8 mA					0.35	0.5			
Ц	Input current at maximum input voltage		V _{CC} = MAX,	V ₁ = 7 V				0.1			0.1	mA		
μн	High-level input	current	V _{CC} = MAX,	V _I = 2.7 V				20			20	μA		
ηĽ	Low-level input	current	V _{CC} = MAX,	V1 = 0.4 V				-0.4			-0.4	mA		
los	Short-circuit output current	}	V _{CC} = MAX			-20		-100	-20		-100	mA		
	Supply current			550 . OND	'L\$320		42	70		42	70			
Icc	from V _{CC}		V _{CC} = MAX,	FFD at GND	'LS321		47	75		47	75	mA		
Icc'	Supply current from V _{CC} '		V _{CC} = MAX,	V _{CC} ' = MAX,	FFD at GND		4	8		4	8	mA		

+ For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

[‡]All typical values are at V_{CC} = 5 V, V_{CC}' = 5 V, and T_A = 25°C.

 $\frac{8}{5}$ Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second. Outputs F' and \overline{F}' do not have short-circuit protection and these limits do not apply.

switching characteristics, V_{CC} = 5 V, V_{CC} = 5 V, T_A = 25° C

PARAMETER		OUTPUTS	TEAT OO		'LS320)		UNIT			
		0017013	TEST CO	MIN	ТҮР	MAX	MIN	ТҮР	MAX	UNIT	
		F/2		R _L = 667 Ω				10	15		
f _{max}	Maximum operating	F/4	C _L = 100 pF	HL - 007 32				5	7.5		MHz
	frequency	All others		R _L = 2 kΩ	20	30		20	30		
	Rise time, 1 V to 3 V		CL = 50 pF	R _L = 667 Ω		6	12		6	12	
		F', F'	C _L ≈ 100 pF			7	14		7	14	
			CL = 200 pF			7	14		7	14]
tr			C _L = 50 pF			11	22		11	22	ns
		Others	C _L = 100 pF	$R_L = 2 k\Omega$	Ω	25	40		25	40	
			C _L = 200 pF			45	70		45	70	
	Fall time, 3 V to 1 V		CL = 50 pF			5	10		5	10	
		F', F'	CL = 100 pF	RL = 667 Ω		5	10		5	10	
+			CL = 200 pF			6	12		6	12	1
t _r			С _L = 50 рF			6	12		6	12	ns
		Others	CL = 100 pF	100 pF RL = 2 kΩ	10	20		10	20	1	
			C _L = 200 pF			17	30		17	30	1

[¶]Load circuits and voltage waveforms are shown in Section 1.



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TYPICAL APPLICATION DATA

The SN54/74LS320 and 'LS321 are crystal-controlled oscillators. Figure 1 shows the device with all required external components.

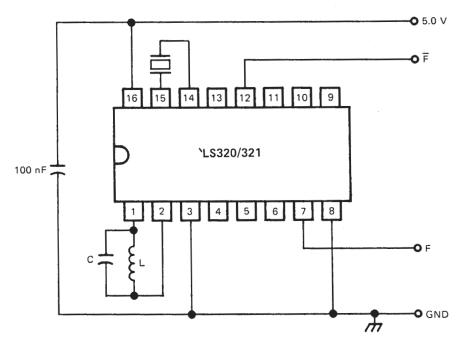


FIGURE 1. CRYSTAL-CONTROLLED OSCILLATOR 'LS320/321

- 1. Determination of C and L are as follows:
 - a. Inductance L
 - Select Inductance L according to Figure 2.

b. Capacitor C

C = CS-CP-CL

- Where: Cp = parasitic board capacitance
 - CL = parasitic capacitance of the inductor
 - L = inductance
 - Cs = required capacitance calculated as follows:

$$C_{S} = \frac{1}{(2 \cdot \pi \cdot f_{q})^{2} \cdot L}$$

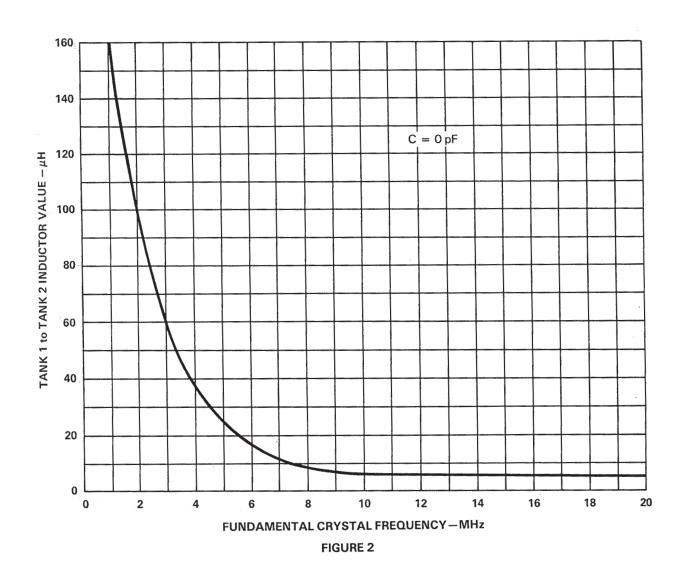
for $f_q > 12 \text{ MHz}$, C = 0 pf

 Electrical characteristic for the crystal: The quartz crystal used as a frequency reference should be designed for series mode operation with a resistance in the 20 Ω to 75 Ω range and be capable of a minimum 2 mw power dissipation.

It is recommended to use a tuned tank also for fundamental crystals.



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